**Summer Research Program at College of Engineering, National Tsing Hua University, Taiwan Application Form**

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| 1. **Basic Information**
 |
| **First Name** |  | **Last Name** |  |
| **Date of Birth** | / 　　 /(YYYY/MM/DD) | **Gender** | (　　) Male(　　) Female |
| **Nationality** |  | **Passport No.** |  |
| **Email Address** |  | **Phone Number** |  |
| 1. **Home Institution**
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| **University** |  | **Location** |  |
| **College** |  | **Current Standing** | (　　) Bachelor, in the \_\_\_\_\_\_\_\_\_\_\_ Year(　　) Master, in the \_\_\_\_\_\_\_\_\_\_\_\_\_ Year(　　) PhD, in the \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ Year |
| **Department/****Institute** |  |
| **Major** |  | **Cumulative GPA** |  |
| 1. **Host Institution & Program Application**
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| **University** | National Tsing Hua University | **Location** | Hsinchu City, Taiwan |
| **College** | College of Engineering | **Program Period** | (　　) Session I: May 15th, 2024 ~ July 15th, 2024(　　) Session II: June 19th, 2024 ~August 19th, 2024 |
| **Department/****Institute** | (　　) Department of Chemical Engineering(　　) Department of Power Mechanical Engineering(　　) Department of Materials Science and Engineering(　　) Department of Industrial Engineering and Engineering Management(　　) Institute of Nano-Engineering and Micro-Systems(　　) Institute of Biomedical Engineering(　　) I would like to be assigned to the Host Department/Institute based on my research interests. |
| **Host Professor** | (　　) I've made contacts and found Prof. \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ as my program advisor.(　　) I'd like the Host Institution to assign me my program advisor. |
| **Research Interests** | 1. |
| 2. |
| 3. |
| **I would like to apply for the University Residence Halls for my stay.** | (　　) Yes(　　) No |
| **I would like to apply for the Scholarship.** | (　　) Yes(　　) No |
| **If not granted the Scholarship, I am still willing to join the program and self-fund the expenses.** | (　　) Yes(　　) No |
| 1. **Confirmation**
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| **I confirm the information provided above is complete and correct.** | Applicant’s Signature & Signing Date: |